



Practitioner's Docket No. IR 3683 NP

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Martyak, N.

Application No.: 10/620,042

Group No.: not yet assigned

Filed: 07/15/03

Examiner: not yet assigned

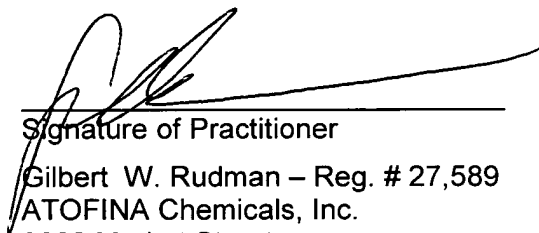
For: ELECTROLYTIC COPPER PLATING SOLUTIONS

**Mail Stop Non-Fee Amendment**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

**PRELIMINARY AMENDMENT**

Preliminary to the examination of the above-captioned patent application, under the heading, **Reference to Related Application**, on the first page, it should be noted that the captioned application claims priority of United States Provisional Application Serial No. 60/403,954 filed August 16, 2002 which is a continuation in part of USSN 09/667,268, filed 09/22/2002, which claims the benefit of United States Provisional Application Serial No. 60/159,381, filed October 14, 1999 and United States Provisional Application Serial No. 60/187,108, filed March 6, 2000.

Date: October 14, 2003

  
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Signature of Practitioner

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**CERTIFICATION UNDER 37 C.F.R. " 1.8(a) and 1.10"**

I hereby certify that, on October 14, 2003 this correspondence is being deposited with the United States Postal Service in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 with sufficient postage as first class mail.

  
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Signature

Meleah J. Scott  
(type or print name of person certifying)